



APPLICATION DATA SHEET

Application Information

Application number::	09/697,305
Filing Date::	10/27/00
Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	2133
CD-ROM or CD-R?::	None
Number of CD disks::	None
Number of copies of CDs::	None
Sequence submission::	
Computer Readable Form (CRF)::	No
Number of copies of CRF::	None
Title::	FAULT DETECTING METHOD AND LAYOUT METHOD FOR SEMICONDUCTOR INTEGRATED CIRCUIT
Attorney Docket Number::	YMOR:186
Request for Early Publication::	No
Request for Non-Publication::	No
Suggested Drawing Figure::	1
Total Drawing Sheets::	50
Small Entity::	No
Latin Name::	
Variety denomination name::	
Petition included::	No
Petition Type::	None
Licensed US Govt. Agency::	None

Initial 04/30/04

Contract or Grant Numbers:: None

Secrecy Order in Parent Appln.?:: No

**Applicant Information**

Applicant Authority Type:: Inventor

Primary Citizenship  
Country::

Japan

Status:: Full Capacity

Given Name:: Takaki

Middle Name::

Family Name:: Yoshida

Name Suffix::

City of Residence:: Ibaraki-shi

State or Province of  
Residence::

Osaka

Country of Residence:: Japan

Street of mailing address:: c/o Matsushita Electric Ind.  
Co., Ltd., 1006, Oaza Kadoma

City of mailing address:: Kadoma-shi

State or Province of  
mailing address::

Osaka

Country of mailing address:: Japan

Postal or Zip Code of  
mailing address::

571-8501

Initial 04/30/04

Given Name:: Reisuke  
Middle Name::  
Family Name:: Shimoda  
Name Suffix::  
City of Residence:: Mishima-gun  
State or Province of  
Residence:: Osaka  
Country of Residence:: Japan  
Street of mailing address:: c/o Matsushita Electric Ind.  
Co., Ltd., 1006, Oaza Kadoma  
City of mailing address:: Kadoma-shi  
State or Province of  
mailing address:: Osaka  
Country of mailing address:: Japan  
Postal or Zip Code of  
mailing address:: 571-8501

Correspondence Information

Correspondence Customer Number:: 6160

Representative Information

Representative Customer Number:: 6160

Initial 04/30/04

**Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application			

**Foreign Priority Information**

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	11-307872	10/29/99	Yes

**Assignee Information**

Assignee name:: Matsushita Electric Industrial Co., Ltd.

Street of mailing address:: 1006, Oaza Kodoma

City of mailing address:: Kadoma-shi

State or Province of mailing address:: Osaka

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 571-8501

Initial 04/30/04